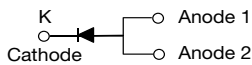


## High Current Density Standard Avalanche Surface-Mount Rectifiers

### eSMP® Series



### SMPC (TO-277A)



### LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	4.0 A
$V_{RRM}$	200 V, 400 V, 600 V, 800 V, 1000 V
$I_{FSM}$	100 A
$E_{AS}$	20 mJ
$V_F$ at $I_F = 4$ A	0.92 V
$T_J$ max.	175 °C
Package	SMPC (TO-277A)
Circuit configuration	Single

### FEATURES

- Very low profile - typical height of 1.1 mm
- Ideal for automated placement
- Glass passivated pellet chip junction
- Controlled avalanche characteristics
- Low leakage current
- High forward surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available  
- Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



### TYPICAL APPLICATIONS

For use in general purpose rectification of power supplies, inverters, converters and freewheeling diodes for consumer, automotive and telecommunication.

### MECHANICAL DATA

**Case:** SMPC (TO-277A)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3\_X - halogen-free, RoHS-compliant and AEC-Q101 qualified ("X" denotes revision code e.g. A, B,.....)

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 1A whisker test, HM3 suffix meets JESD 201 class 2 whisker test

MAXIMUM RATINGS ( $T_A = 25$ °C unless otherwise noted)							
PARAMETER	SYMBOL	AS4PD	AS4PG	AS4PJ	AS4PK	AS4PM	UNIT
Device marking code		AS4D	AS4G	AS4J	AS4K	AS4M	
Max. repetitive peak reverse voltage	$V_{RRM}$	200	400	600	800	1000	V
Max. DC forward current (fig. 1)	$I_F^{(1)}$	4.0					A
	$I_F^{(2)}$	2.4					
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	$I_{FSM}$	100					A
Non-repetitive avalanche energy at $T_J = 25$ °C	$I_{AS} = 2.5$ A max.	20					mJ
	$I_{AS} = 1.0$ A typical	30					
Operating junction and storage temperature range	$T_J, T_{STG}$	-55 to +175					°C

### Notes

(1) Mounted on 20 mm x 20 mm pad areas, 1 oz. FR4 PCB

(2) Free air, mounted on recommended copper pad area



ELECTRICAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I <sub>F</sub> = 2.0 A	T <sub>A</sub> = 25 °C	V <sub>F</sub> <sup>(1)</sup>	0.962	-	V
	I <sub>F</sub> = 4.0 A			1.044	1.10	
	I <sub>F</sub> = 2.0 A	T <sub>A</sub> = 125 °C		0.822	-	
	I <sub>F</sub> = 4.0 A			0.922	0.98	
Reverse current	rated V <sub>R</sub>	T <sub>A</sub> = 25 °C	I <sub>R</sub> <sup>(2)</sup>	0.35	10	µA
		T <sub>A</sub> = 125 °C		75	150	
Typical reverse recovery time	I <sub>F</sub> = 0.5 A, I <sub>R</sub> = 1.0 A, I <sub>rr</sub> = 0.25 A		t <sub>rr</sub>	1.8	-	µs
Typical junction capacitance per diode	4.0 V, 1 MHz		C <sub>J</sub>	60	-	pF

**Notes**

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 40 ms

THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise noted)							
PARAMETER	SYMBOL	AS4PD	AS4PG	AS4PJ	AS4PK	AS4PM	UNIT
Typical thermal resistance	R <sub>θJA</sub> <sup>(1)</sup>	80					°C/W
	R <sub>θJM</sub> <sup>(2)</sup>	5					

**Notes**

(1) Free air, mounted on recommended PCB 1 oz. pad area; thermal resistance R<sub>θJA</sub> - junction to ambient

(2) Units mounted on PCB with 20 mm x 20 mm copper pad areas, 1 oz. FR4 PCB; R<sub>θJM</sub> - junction to mount

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
AS4PJ-M3/86A	0.10	86A	1500	7" diameter plastic tape and reel
AS4PJ-M3/87A	0.10	87A	6500	13" diameter plastic tape and reel
AS4PJHM3_A/H <sup>(1)</sup>	0.10	H	1500	7" diameter plastic tape and reel
AS4PJHM3_A/I <sup>(1)</sup>	0.10	I	6500	13" diameter plastic tape and reel

**Note**

(1) AEC-Q101 qualified



## RATINGS AND CHARACTERISTICS CURVES ( $T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)

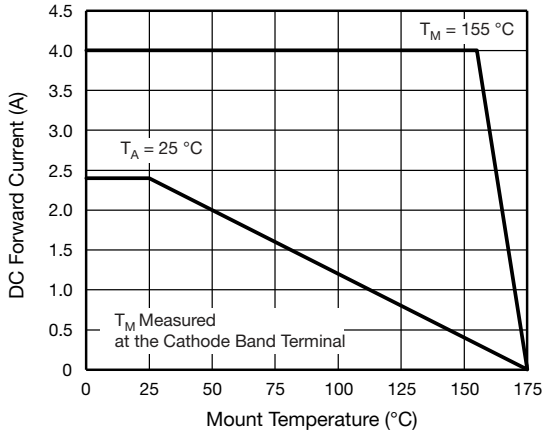


Fig. 1 - Max. Forward Current Derating Curve

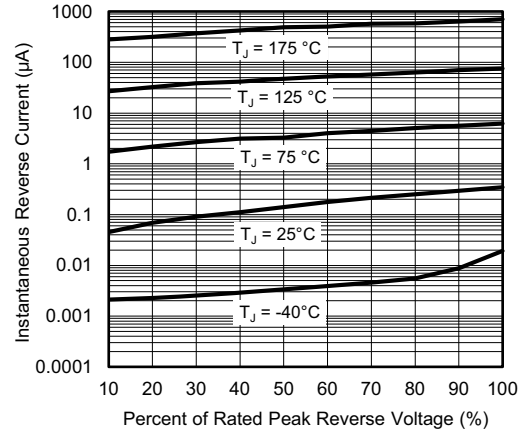


Fig. 4 - Typical Reverse Leakage Characteristics

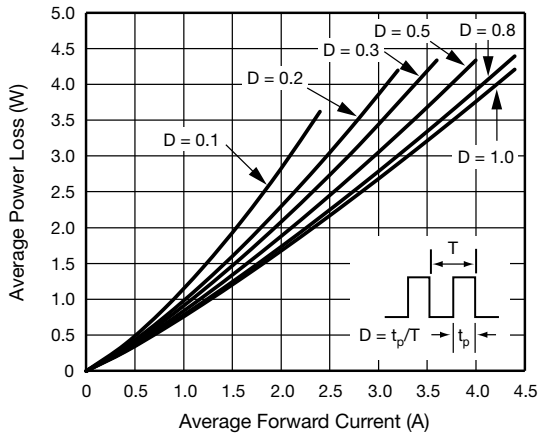


Fig. 2 - Forward Power Loss Characteristics

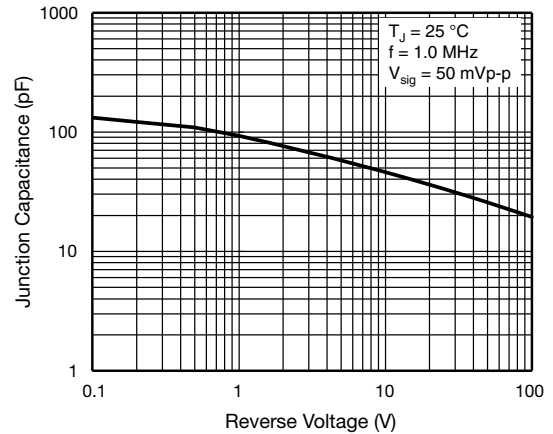


Fig. 5 - Typical Junction Capacitance

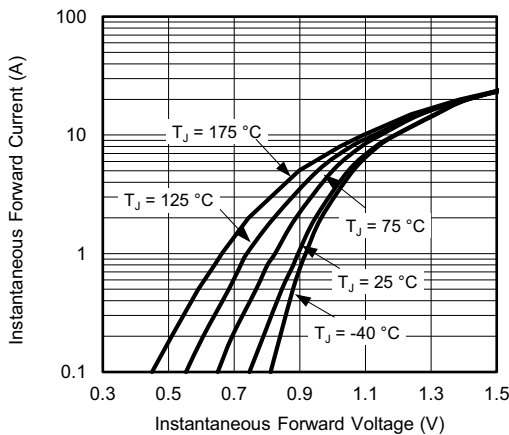


Fig. 3 - Typical Instantaneous Forward Characteristics

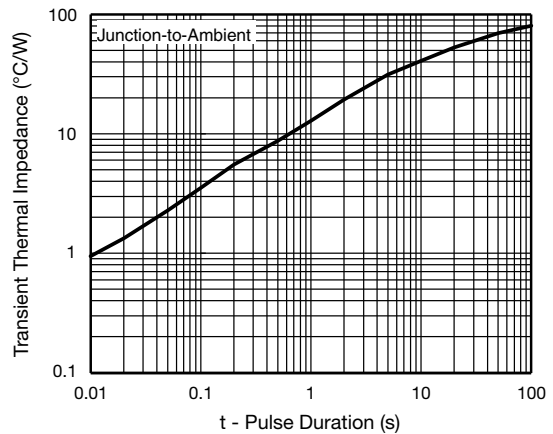
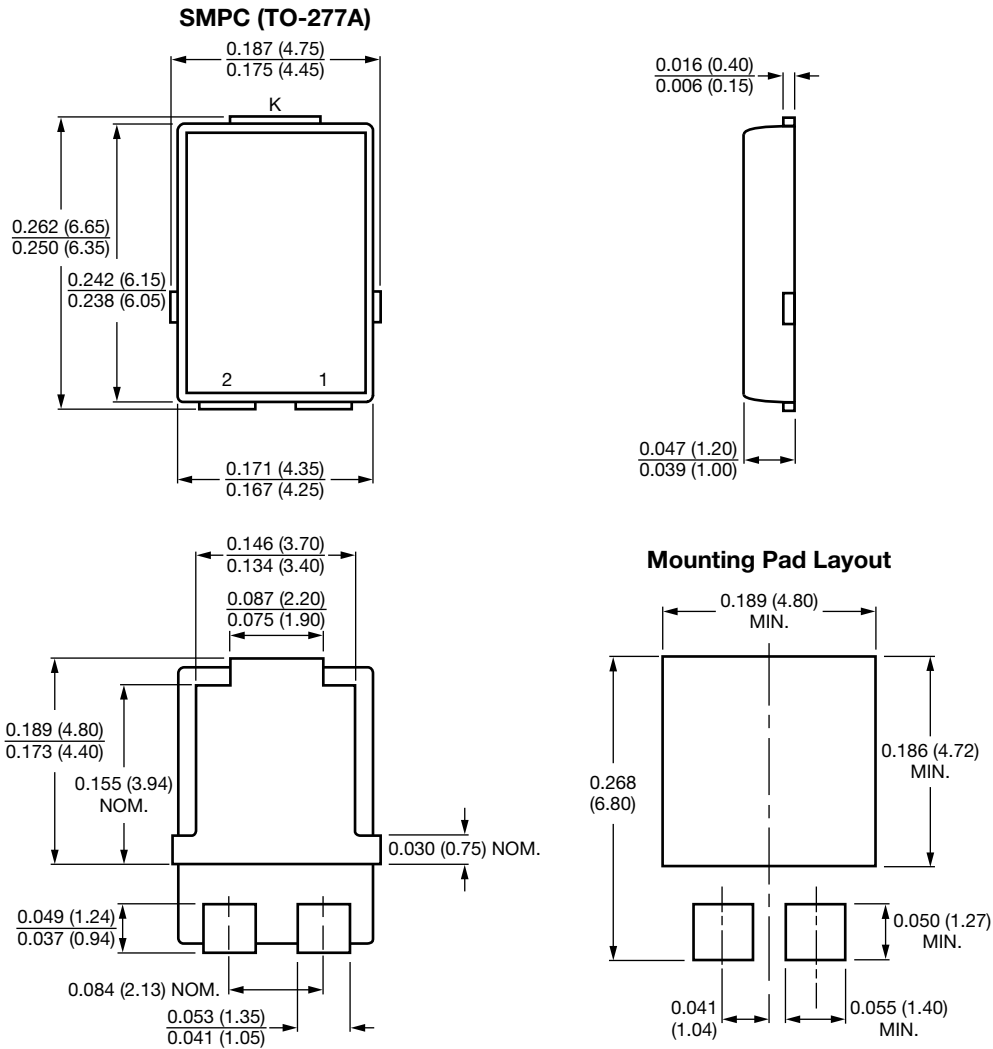


Fig. 6 - Typical Transient Thermal Impedance



### PACKAGE OUTLINE DIMENSIONS in inches (millimeters)



Conform to JEDEC® TO-277A



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